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PROTECTION PRODUCTS - RailClamp®

Description

RClamp®3521P provides ESD protection for USB3.0 and other high-speed ports. It may be used to meet the ESD immunity requirements of IEC 61000-4-2. RClamp3521P is designed to minimize both the ESD peak clamping and the TLP clamping. The dynamic resistance is minimized (0.47 Ohms typical) for optimum protection of sensitive circuits. Maximum capacitance is only 0.40pF. This allows the RClamp3521P to be used in applications operating in excess of 5GHz without appreciable signal attenuation. These devices are manufactured using Semtech's proprietary low voltage technology for superior electrical characteristics. RClamp3521P is in a 2-pin SLP1006P2 package. It measures 1.0 x 0.6 x 0.5mm. Leads are spaced at a pitch of 0.65mm and are finished with lead-free NiPdAu. Each device will protect one line operating up to 3.5 volts. The combination of low peak ESD clamping, low dynamic resistance, and low capacitance makes this device suitable for applications such as USB 3.0, audio and V-By-One interfaces in portable devices.

Features

- ◆ Transient protection for data lines to **IEC 61000-4-2 (ESD) ±17kV (air), ±12kV (contact) IEC 61000-4-4 (EFT) 40A (tp = 5/50ns) Cable Discharge Event (CDE)**
- ◆ Ultra-small package (1.0 x 0.6 x 0.5mm)
- ◆ Protects one data or I/O line
- ◆ Low capacitance: **0.40pF**
- ◆ Dynamic Resistance: 0.47 Ohms Typical
- ◆ Low ESD clamping voltage
- ◆ Operating voltage: 3.5V
- ◆ Solid-state silicon-avalanche technology

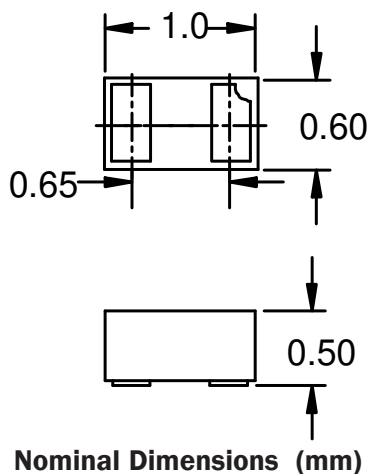
Mechanical Characteristics

- ◆ SLP1006P2 package
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking: Marking code
- ◆ Packaging: Tape and Reel
- ◆ Lead Finish: NiPdAu
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant

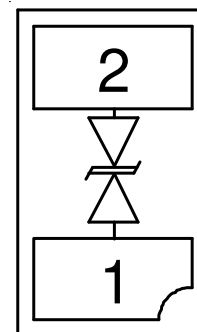
Applications

- ◆ USB 2.0 / USB 3.0
- ◆ V-By-One
- ◆ Display Port
- ◆ MHL / MDDI
- ◆ LVDS Interfaces
- ◆ eSATA Interfaces

Dimensions



Schematic & Pin Configuration



SLP1006P2 (Bottom View)

PROTECTION PRODUCTS
Absolute Maximum Rating

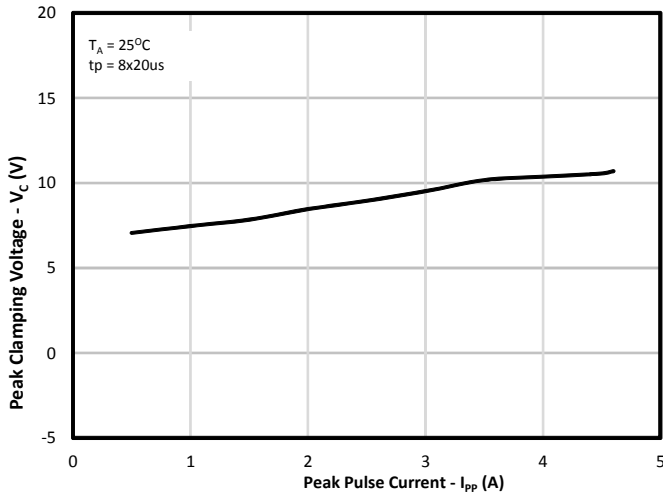
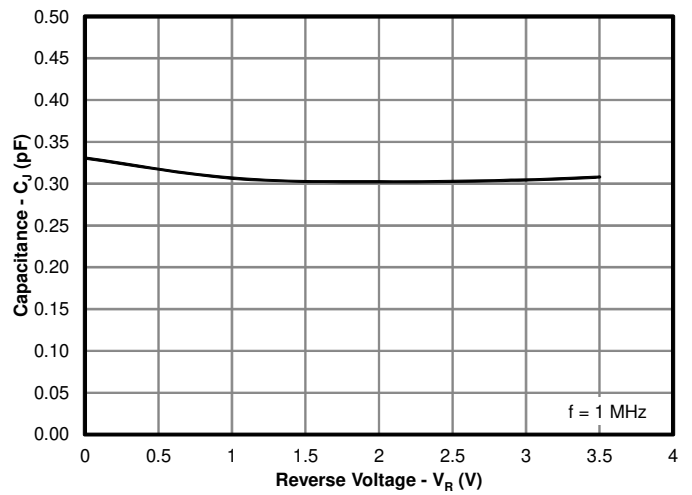
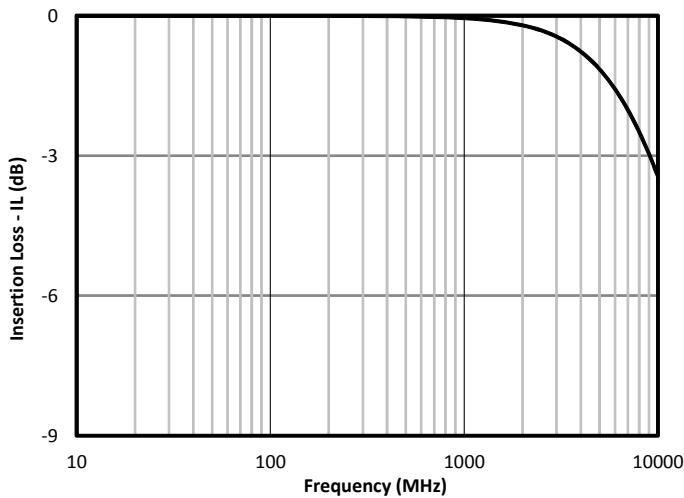
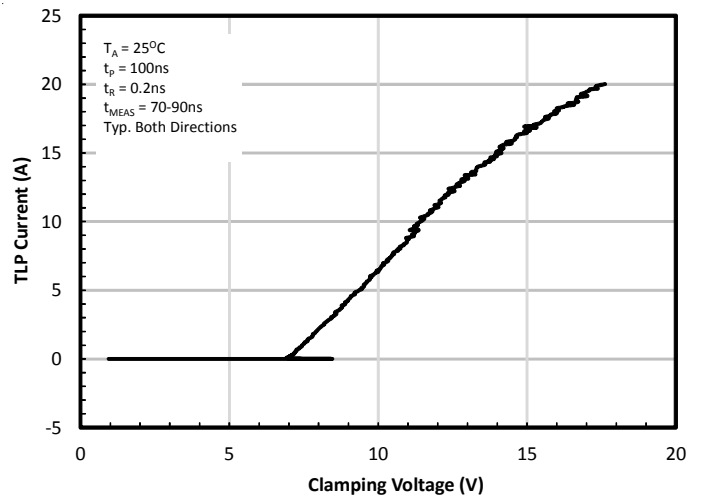
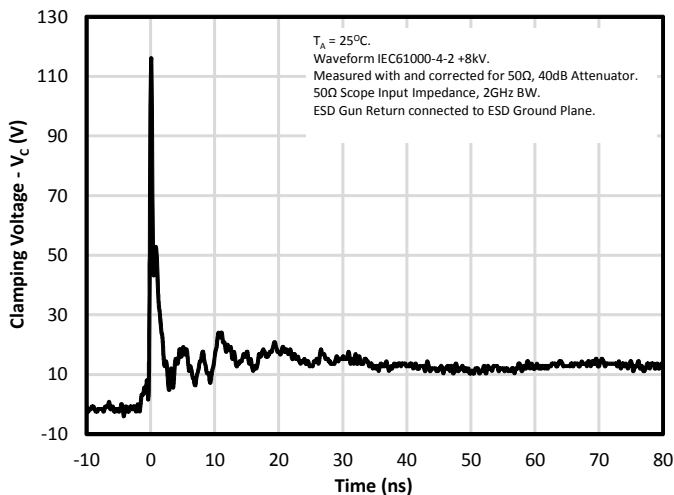
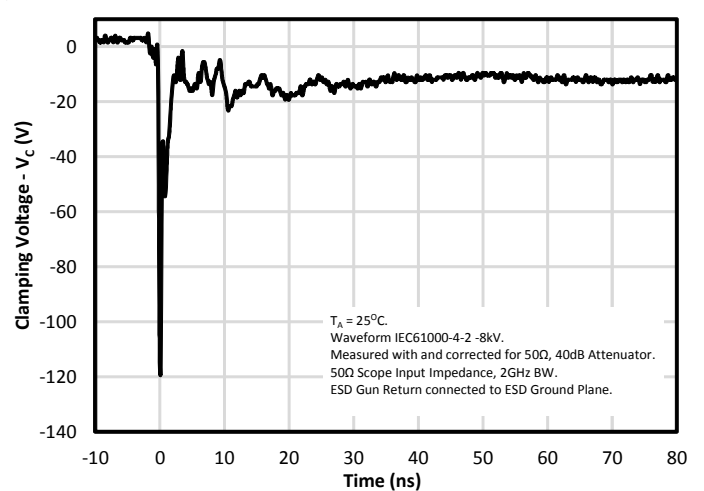
Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{pk}	50	Watts
Maximum Peak Pulse Current ($t_p = 8/20\mu s$)	I_{pp}	4	Amps
ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹	V_{ESD}	+/- 17 +/- 12	kV
Operating Temperature	T_J	-40 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

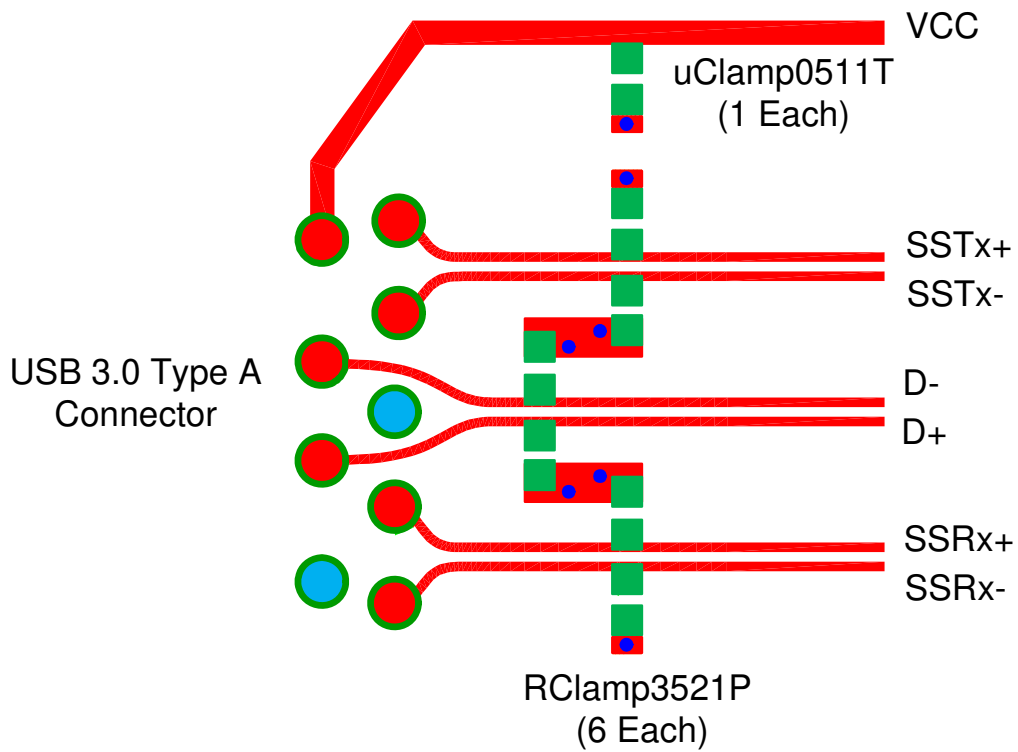
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				3.5	V
Breakdown Voltage	V_{BR}	$I_{BR} = 1mA$	4.5	6.7	8.5	V
Reverse Leakage Current	I_R	$V_{RWM} = 3.5V$		0.01	0.05	μA
Clamping Voltage	V_C	$I_{pp} = 1A, t_p = 8/20\mu s$		9.5	10	V
Clamping Voltage	V_C	$I_{pp} = 4A, t_p = 8/20\mu s$		10.5	13	V
ESD Clamping Voltage ²	V_C	$I_{pp} = 4A,$ $t_{lp} = 0.2/100ns$		8.8		V
ESD Clamping Voltage ²	V_C	$I_{pp} = 16A,$ $t_{lp} = 0.2/100ns$		14.5		V
Trigger Voltage ²	V_{TRIG}	$t_{lp} = 0.2/100ns$		8		V
Dynamic Resistance ^{2, 3}	R_{DYN}	$t_{lp} = 0.2 / 100ns$		0.47		Ohms
Junction Capacitance	C_J	$V_R = 0V, f = 1MHz$		0.33	0.40	pF

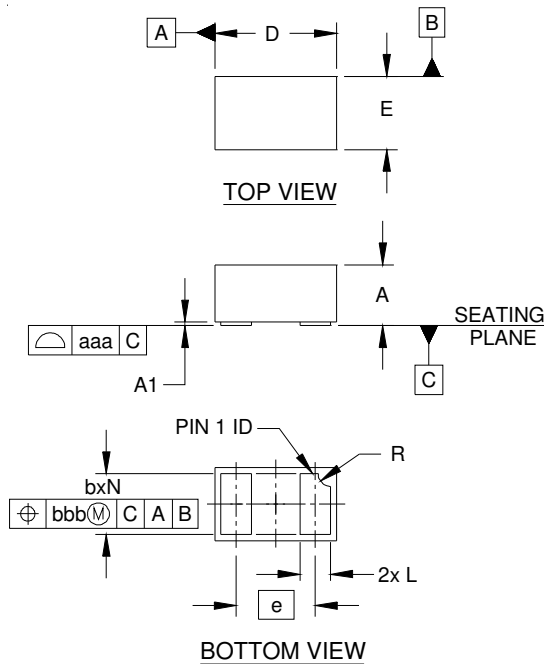
Notes

- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: $t_p = 100ns$, $t_r = 0.2ns$, I_{TLP} and V_{TLP} averaging window: $t_1 = 70ns$ to $t_2 = 90ns$.
- 3) Dynamic resistance calculated from $I_{pp} = 4A$ to $I_{pp} = 16A$
- 4) Device is electrically symmetrical

PROTECTION PRODUCTS
Typical Characteristics
Clamping Voltage vs. Peak Pulse Current

Capacitance vs. Reverse Voltage

Typical Insertion Loss (S21)

TLP Characteristic

ESD Clamping (+8kV Contact per IEC 61000-4-2)

ESD Clamping (-8kV Contact per IEC 61000-4-2)




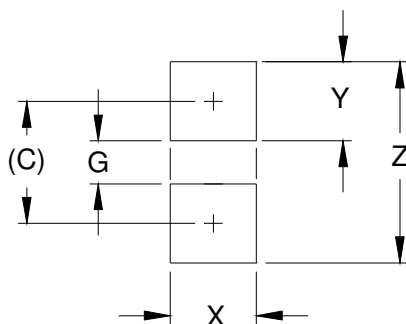
USB 3.0 Layout Diagram

PROTECTION PRODUCTS
Outline Drawing - SLP1006P2


DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.016	.020	.022	0.40	0.50	0.55
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
e	.026 BSC			0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003			0.08		
bbb	.004			0.10		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP1006P2


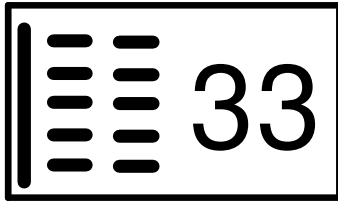
DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.033)	(0.85)
G	.012	0.30
X	.024	0.60
Y	.022	0.55
Z	.055	1.40

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

PROTECTION PRODUCTS

Marking Codes



Ordering Information

Part Number	Qty per Reel	Reel Size
RClamp3521P.TNT	10,000	7 Inch

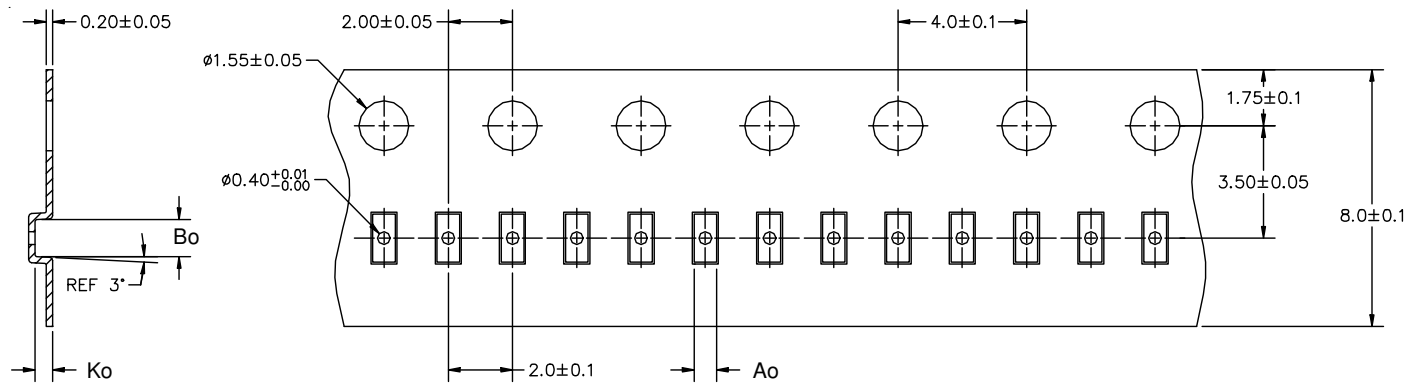
Notes:

RailClamp and RClamp are trademarks of Semtech Corporation

Notes:

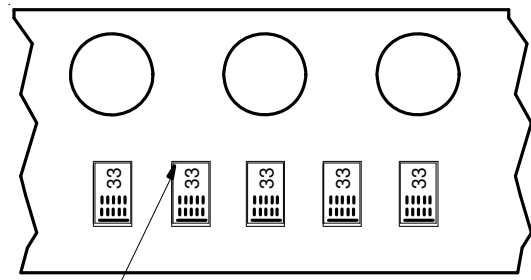
- 1) Device is electrically symmetrical
- 2) Marking will also include line matrix date code

Carrier Tape Specification



A0	B0	K0
0.69 +/-0.10 mm	1.19 +/-0.10 mm	0.66 +/-0.10 mm

Note: All dimensions in mm unless otherwise specified



Pin 1 Location
(Towards Sprocket Holes)

Device Orientation in Tape

Contact Information

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